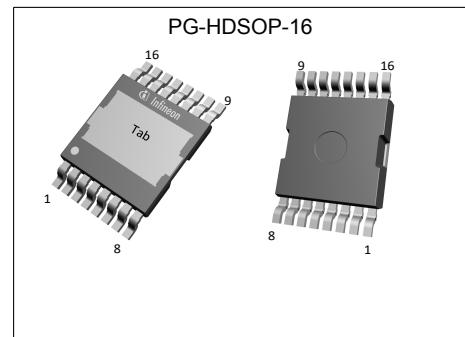


# MOSFET

OptiMOS™ 5 Power-Transistor, 150 V

## Features

- N-channel, normal level
- Very low on-resistance  $R_{DS(on)}$
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

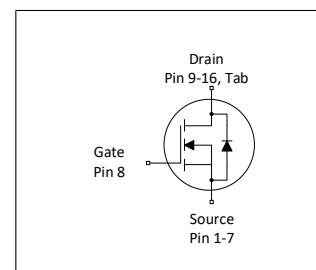


## Product validation

Fully qualified according to JEDEC for Industrial Applications

**Table 1 Key Performance Parameters**

Parameter	Value	Unit
$V_{DS}$	150	V
$R_{DS(on),max}$	4.4	mΩ
$I_D$	174	A
$Q_{oss}$	200	nC
$Q_G$	71	nC



RoHS

Type / Ordering Code	Package	Marking	Related Links
IPTC044N15NM5	PG-HDSOP-16	044N15N5	-

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## 1 Maximum ratings

at  $T_A=25\text{ }^\circ\text{C}$ , unless otherwise specified

**Table 2 Maximum ratings**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Continuous drain current <sup>1)</sup>	$I_D$	-	-	174	A	$V_{GS}=10\text{ V}, T_C=25\text{ }^\circ\text{C}$
		-	-	123		$V_{GS}=10\text{ V}, T_C=100\text{ }^\circ\text{C}$
		-	-	115		$V_{GS}=8\text{ V}, T_C=100\text{ }^\circ\text{C}$
		-	-	19.4		$V_{GS}=10\text{V}, T_A=25\text{ }^\circ\text{C}, R_{thJA}=40\text{ }^\circ\text{C/W}^2$
Pulsed drain current <sup>3)</sup>	$I_{D,pulse}$	-	-	696	A	$T_A=25\text{ }^\circ\text{C}$
Avalanche energy, single pulse <sup>4)</sup>	$E_{AS}$	-	-	321	mJ	$I_D=100\text{ A}, R_{GS}=25\text{ }\Omega$
Gate source voltage	$V_{GS}$	-20	-	20	V	-
Power dissipation	$P_{tot}$	-	-	300	W	$T_C=25\text{ }^\circ\text{C}$
		-	-	3.8		$T_A=25\text{ }^\circ\text{C}, R_{thJA}=40\text{ }^\circ\text{C/W}^2$
Operating and storage temperature	$T_j, T_{stg}$	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

## 2 Thermal characteristics

**Table 3 Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	$R_{thJC}$	-	-	0.5	°C/W	-
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>2)</sup>	$R_{thJA}$	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimum footprint	$R_{thJA}$	-	-	62	°C/W	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

<sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

### 3 Electrical characteristics

at  $T_j=25^\circ\text{C}$ , unless otherwise specified

**Table 4 Static characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	150	-	-	V	$V_{\text{GS}}=0\text{ V}$ , $I_D=1\text{ mA}$
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	3.0	3.8	4.6	V	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D=235\text{ }\mu\text{A}$
Zero gate voltage drain current	$I_{\text{DSS}}$	-	0.1 10	1.0 100	$\mu\text{A}$	$V_{\text{DS}}=120\text{ V}$ , $V_{\text{GS}}=0\text{ V}$ , $T_j=25^\circ\text{C}$ $V_{\text{DS}}=120\text{ V}$ , $V_{\text{GS}}=0\text{ V}$ , $T_j=125^\circ\text{C}$
Gate-source leakage current	$I_{\text{GSS}}$	-	10	100	nA	$V_{\text{GS}}=20\text{ V}$ , $V_{\text{DS}}=0\text{ V}$
Drain-source on-state resistance	$R_{\text{DS}(\text{on})}$	-	3.7 4.0	4.4 5.0	$\text{m}\Omega$	$V_{\text{GS}}=10\text{ V}$ , $I_D=50\text{ A}$ $V_{\text{GS}}=8\text{ V}$ , $I_D=25\text{ A}$
Gate resistance <sup>1)</sup>	$R_G$	-	0.9	1.3	$\Omega$	-
Transconductance	$g_{\text{fs}}$	-	110	-	S	$ V_{\text{DS}}  \geq 2 I_D R_{\text{DS}(\text{on})\text{max}}$ , $I_D=50\text{ A}$

**Table 5 Dynamic characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input capacitance <sup>1)</sup>	$C_{\text{iss}}$	-	5400	7000	pF	$V_{\text{GS}}=0\text{ V}$ , $V_{\text{DS}}=75\text{ V}$ , $f=1\text{ MHz}$
Output capacitance <sup>1)</sup>	$C_{\text{oss}}$	-	1300	1950	pF	$V_{\text{GS}}=0\text{ V}$ , $V_{\text{DS}}=75\text{ V}$ , $f=1\text{ MHz}$
Reverse transfer capacitance <sup>1)</sup>	$C_{\text{rss}}$	-	30	53	pF	$V_{\text{GS}}=0\text{ V}$ , $V_{\text{DS}}=75\text{ V}$ , $f=1\text{ MHz}$
Turn-on delay time	$t_{\text{d}(\text{on})}$	-	17	-	ns	$V_{\text{DD}}=75\text{ V}$ , $V_{\text{GS}}=10\text{ V}$ , $I_D=50\text{ A}$ , $R_{\text{G,ext}}=1.6\text{ }\Omega$
Rise time	$t_r$	-	5.0	-	ns	$V_{\text{DD}}=75\text{ V}$ , $V_{\text{GS}}=10\text{ V}$ , $I_D=50\text{ A}$ , $R_{\text{G,ext}}=1.6\text{ }\Omega$
Turn-off delay time	$t_{\text{d}(\text{off})}$	-	25	-	ns	$V_{\text{DD}}=75\text{ V}$ , $V_{\text{GS}}=10\text{ V}$ , $I_D=50\text{ A}$ , $R_{\text{G,ext}}=1.6\text{ }\Omega$
Fall time	$t_f$	-	6.5	-	ns	$V_{\text{DD}}=75\text{ V}$ , $V_{\text{GS}}=10\text{ V}$ , $I_D=50\text{ A}$ , $R_{\text{G,ext}}=1.6\text{ }\Omega$

**Table 6 Gate charge characteristics<sup>2)</sup>**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gate to source charge	$Q_{\text{gs}}$	-	29	-	nC	$V_{\text{DD}}=75\text{ V}$ , $I_D=50\text{ A}$ , $V_{\text{GS}}=0$ to $10\text{ V}$
Gate charge at threshold	$Q_{\text{g}(\text{th})}$	-	20	-	nC	$V_{\text{DD}}=75\text{ V}$ , $I_D=50\text{ A}$ , $V_{\text{GS}}=0$ to $10\text{ V}$
Gate to drain charge <sup>1)</sup>	$Q_{\text{gd}}$	-	14	21	nC	$V_{\text{DD}}=75\text{ V}$ , $I_D=50\text{ A}$ , $V_{\text{GS}}=0$ to $10\text{ V}$
Switching charge	$Q_{\text{sw}}$	-	23	-	nC	$V_{\text{DD}}=75\text{ V}$ , $I_D=50\text{ A}$ , $V_{\text{GS}}=0$ to $10\text{ V}$
Gate charge total <sup>1)</sup>	$Q_g$	-	71	89	nC	$V_{\text{DD}}=75\text{ V}$ , $I_D=50\text{ A}$ , $V_{\text{GS}}=0$ to $10\text{ V}$
Gate plateau voltage	$V_{\text{plateau}}$	-	5.4	-	V	$V_{\text{DD}}=75\text{ V}$ , $I_D=50\text{ A}$ , $V_{\text{GS}}=0$ to $10\text{ V}$
Output charge <sup>1)</sup>	$Q_{\text{oss}}$	-	200	266	nC	$V_{\text{DS}}=75\text{ V}$ , $V_{\text{GS}}=0\text{ V}$

<sup>1)</sup> Defined by design. Not subject to production test.

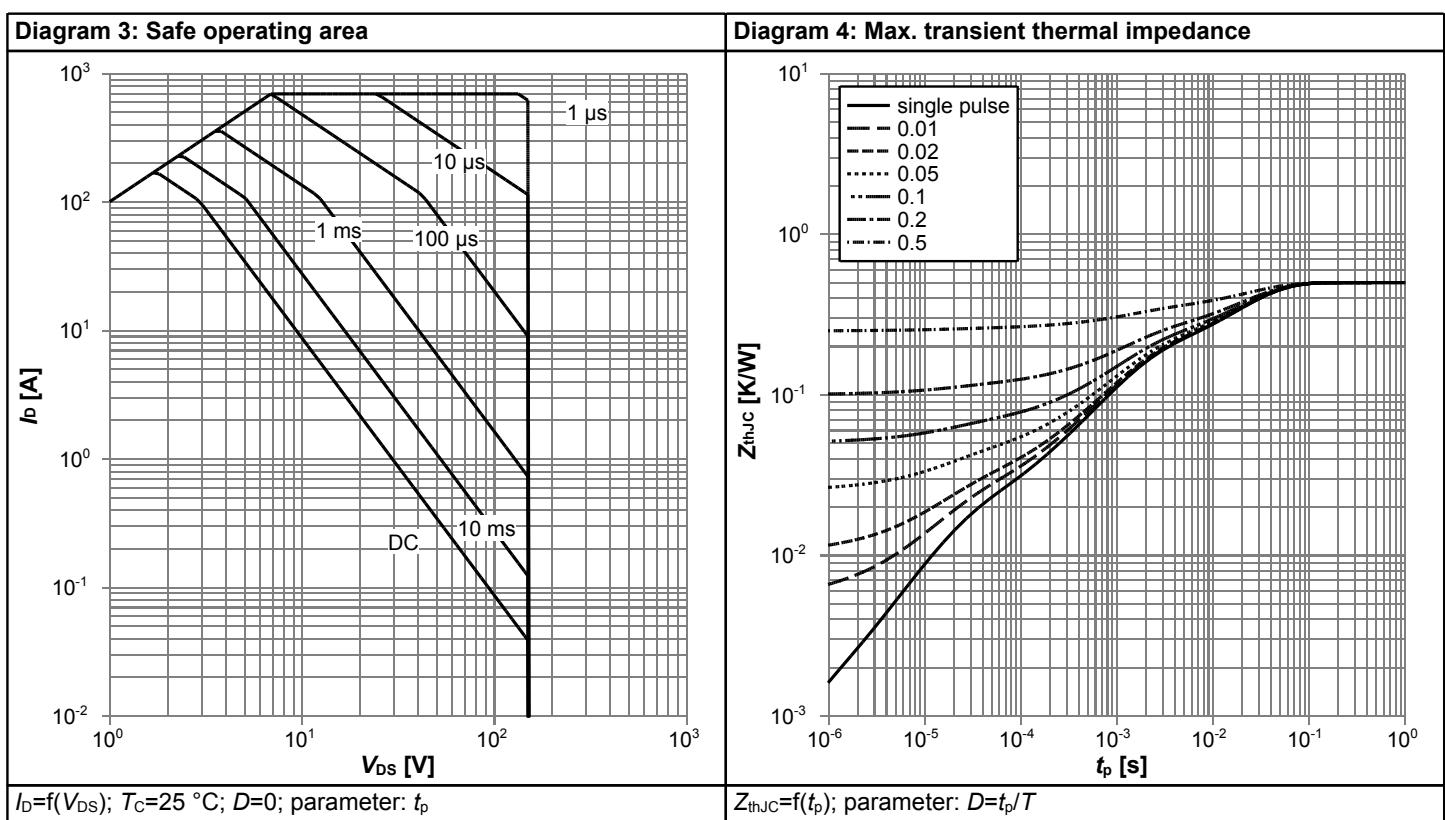
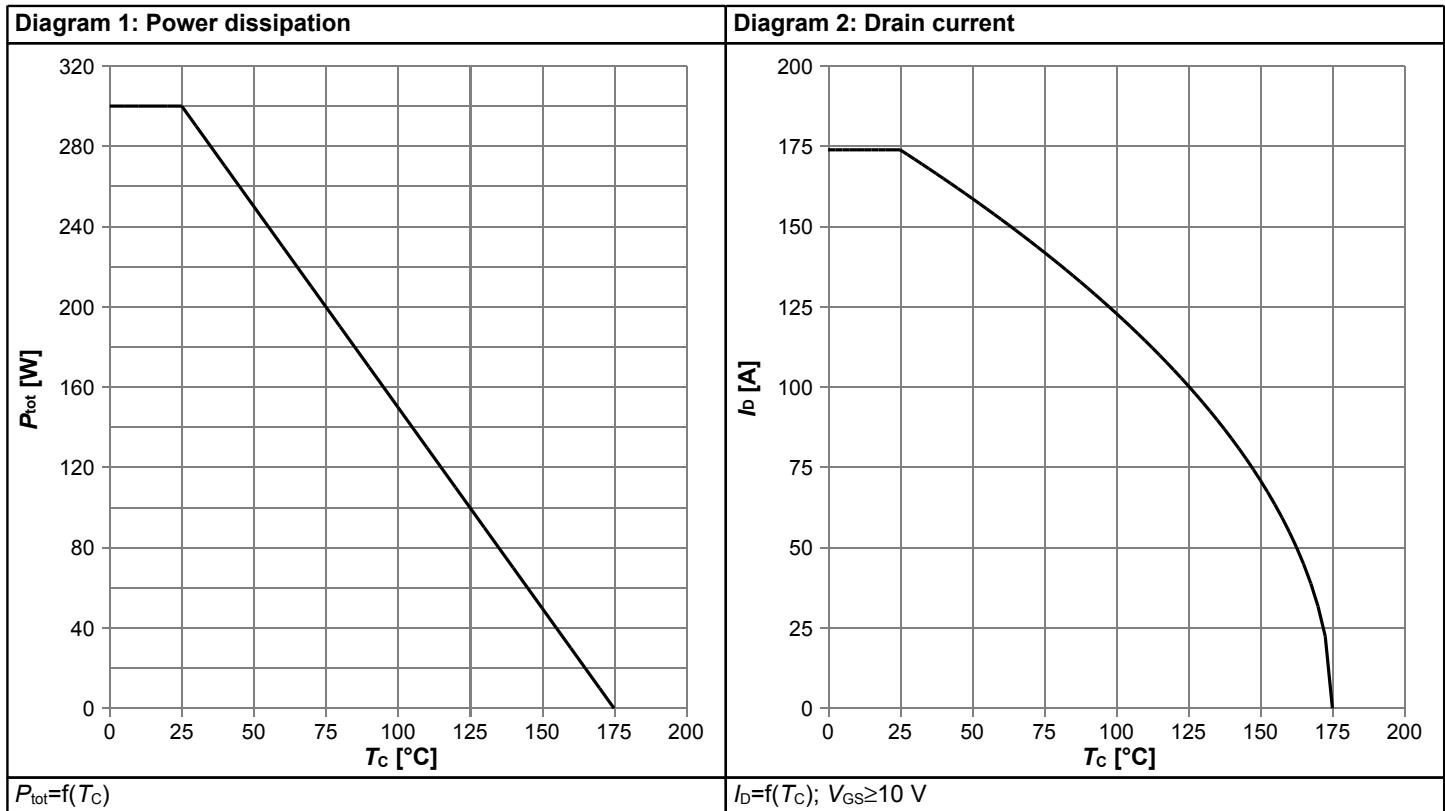
<sup>2)</sup> See "Gate charge waveforms" for parameter definition

**Table 7 Reverse diode**

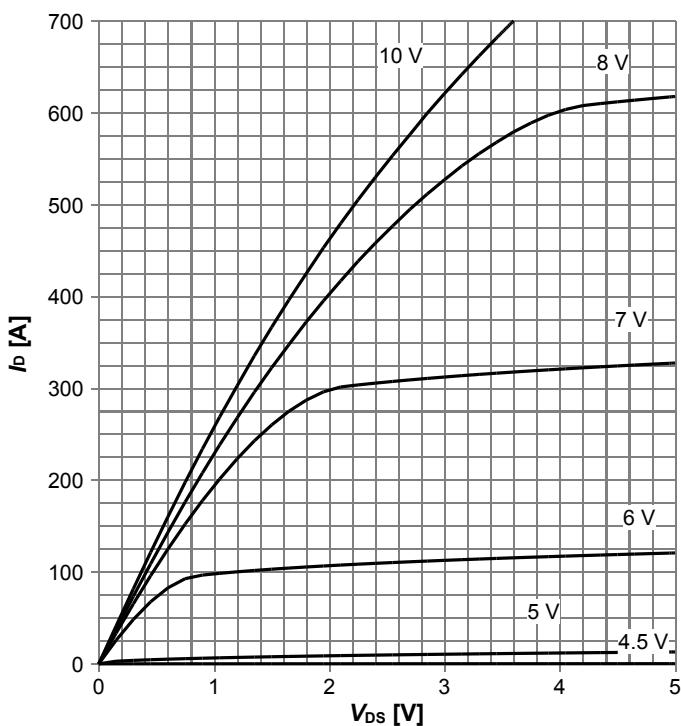
Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode continuous forward current	$I_S$	-	-	174	A	$T_C=25\text{ }^\circ\text{C}$
Diode pulse current	$I_{S,pulse}$	-	-	696	A	$T_C=25\text{ }^\circ\text{C}$
Diode forward voltage	$V_{SD}$	-	0.82	1.0	V	$V_{GS}=0\text{ V}$ , $I_F=50\text{ A}$ , $T_j=25\text{ }^\circ\text{C}$
Reverse recovery time <sup>1)</sup>	$t_{rr}$	-	45	91	ns	$V_R=75\text{ V}$ , $I_F=50\text{ A}$ , $dI_F/dt=100\text{ A}/\mu\text{s}$
Reverse recovery charge <sup>1)</sup>	$Q_{rr}$	-	49	98	nC	$V_R=75\text{ V}$ , $I_F=50\text{ A}$ , $dI_F/dt=100\text{ A}/\mu\text{s}$

<sup>1)</sup> Defined by design. Not subject to production test.

## 4 Electrical characteristics diagrams

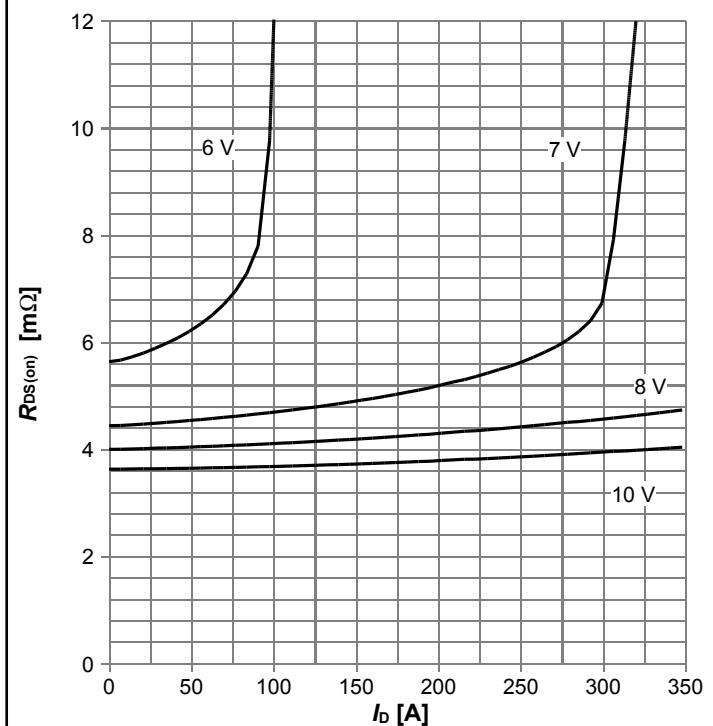


**Diagram 5: Typ. output characteristics**



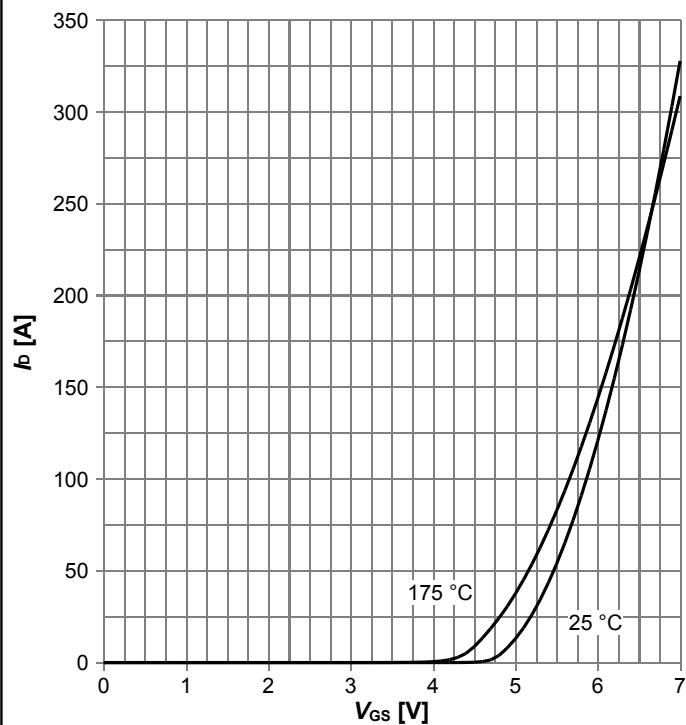
$I_D=f(V_{DS})$ ,  $T_j=25\text{ }^\circ\text{C}$ ; parameter:  $V_{GS}$

**Diagram 6: Typ. drain-source on resistance**



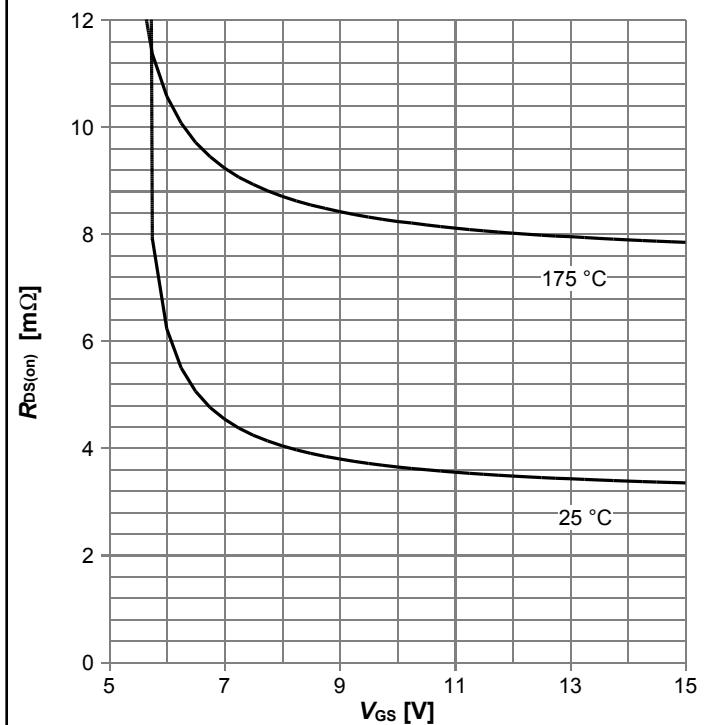
$R_{DS(on)}=f(I_D)$ ,  $T_j=25\text{ }^\circ\text{C}$ ; parameter:  $V_{GS}$

**Diagram 7: Typ. transfer characteristics**



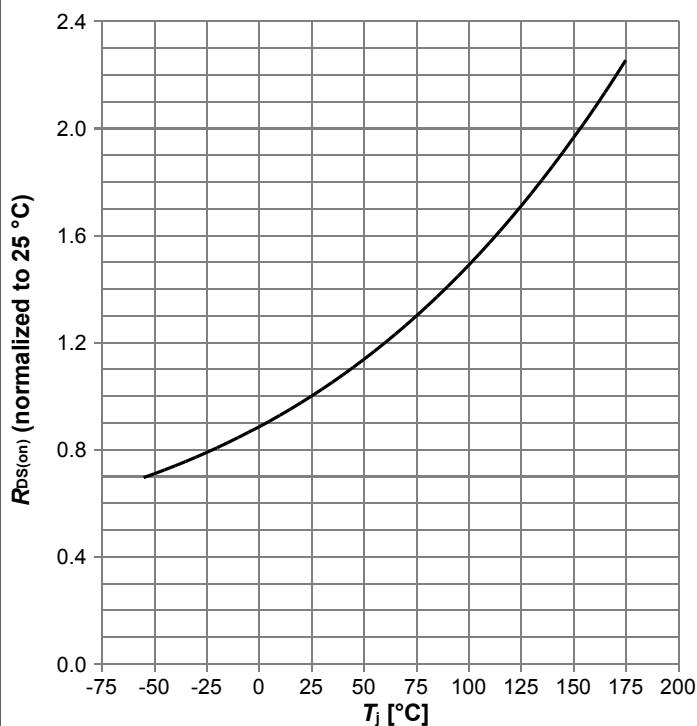
$I_D=f(V_{GS})$ ,  $|V_{DS}|>2|I_D|R_{DS(on)max}$ ; parameter:  $T_j$

**Diagram 8: Typ. drain-source on resistance**



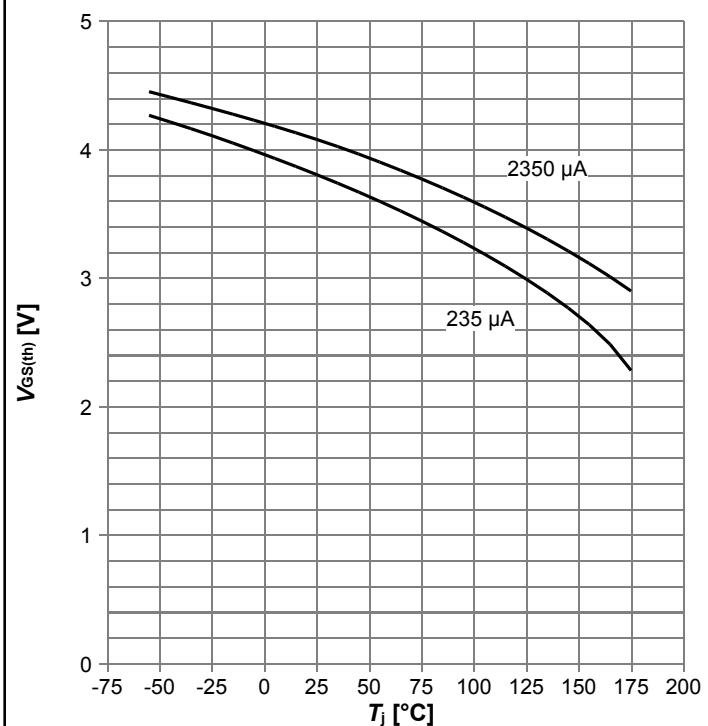
$R_{DS(on)}=f(V_{GS})$ ,  $I_D=50\text{ A}$ ; parameter:  $T_j$

**Diagram 9: Normalized drain-source on resistance**



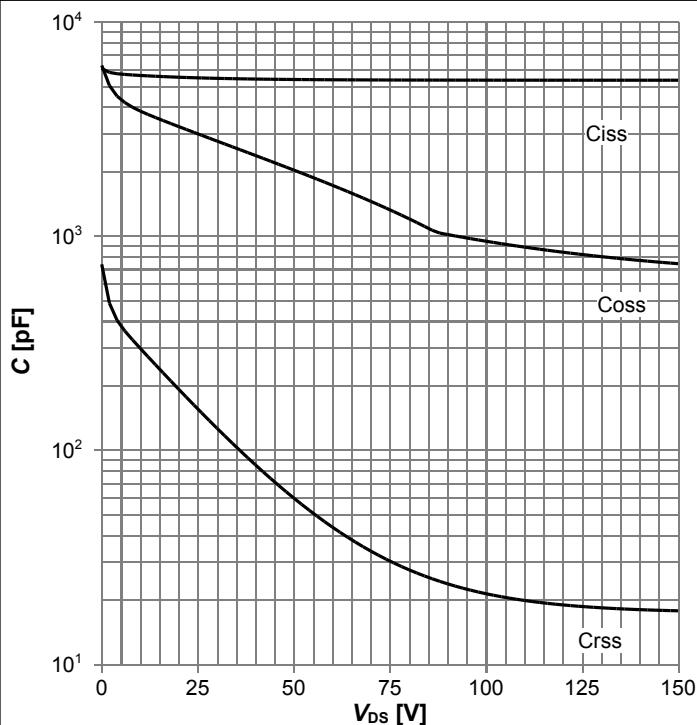
$R_{DS(on)} = f(T_j)$ ,  $I_D = 50 \text{ A}$ ,  $V_{GS} = 10 \text{ V}$

**Diagram 10: Typ. gate threshold voltage**



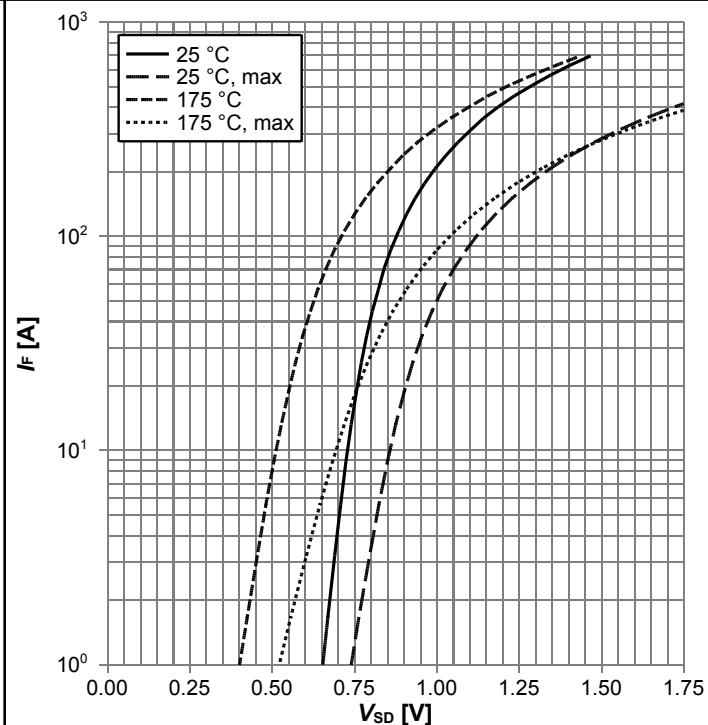
$V_{GS(th)} = f(T_j)$ ,  $V_{GS} = V_{DS}$ ; parameter:  $I_D$

**Diagram 11: Typ. capacitances**



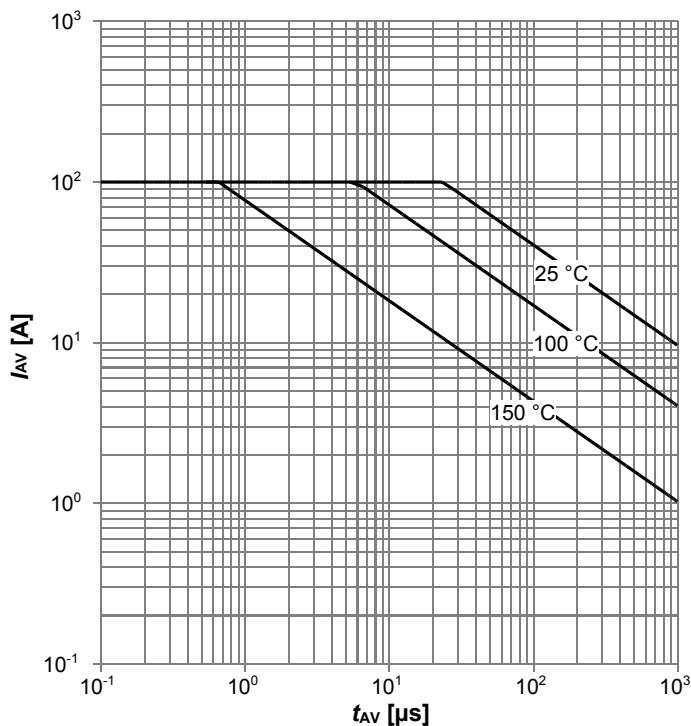
$C = f(V_{DS})$ ;  $V_{GS} = 0 \text{ V}$ ;  $f = 1 \text{ MHz}$

**Diagram 12: Forward characteristics of reverse diode**



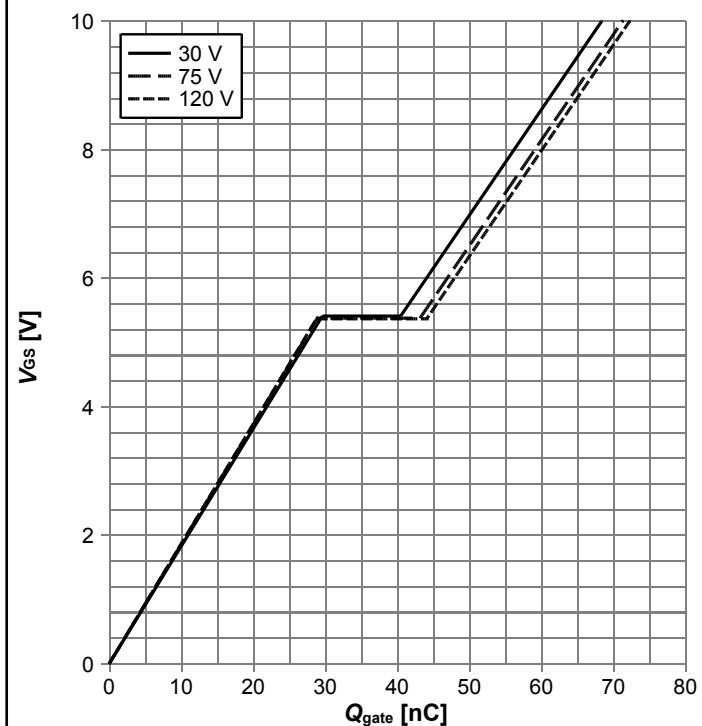
$I_F = f(V_{SD})$ ; parameter:  $T_j$

**Diagram 13: Avalanche characteristics**



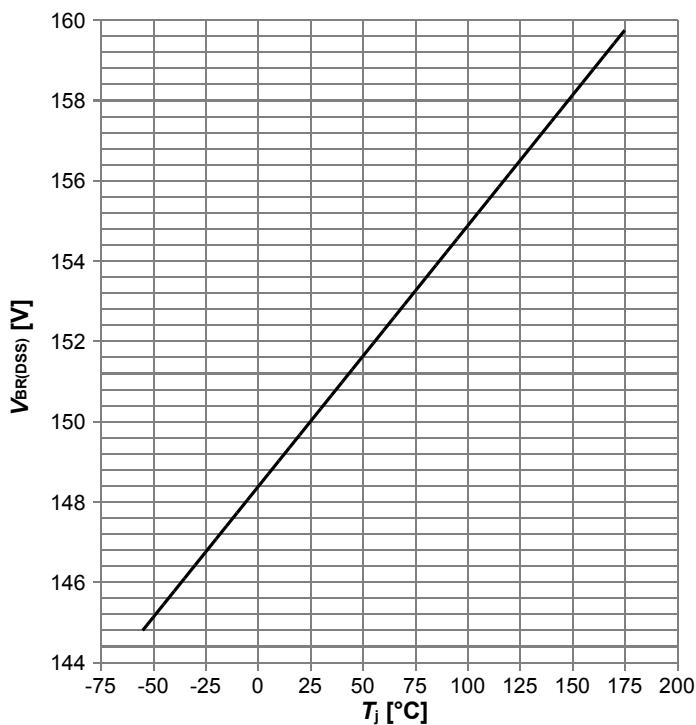
$I_{AS}=f(t_{AV})$ ;  $R_{GS}=25 \Omega$ ; parameter:  $T_{j,start}$

**Diagram 14: Typ. gate charge**



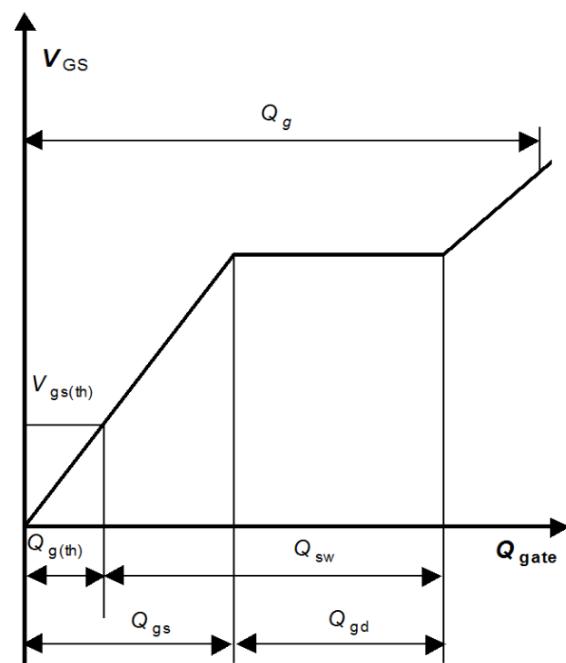
$V_{GS}=f(Q_{gate})$ ,  $I_D=50 \text{ A pulsed}$ ,  $T_j=25^\circ\text{C}$ ; parameter:  $V_{DD}$

**Diagram 15: Drain-source breakdown voltage**

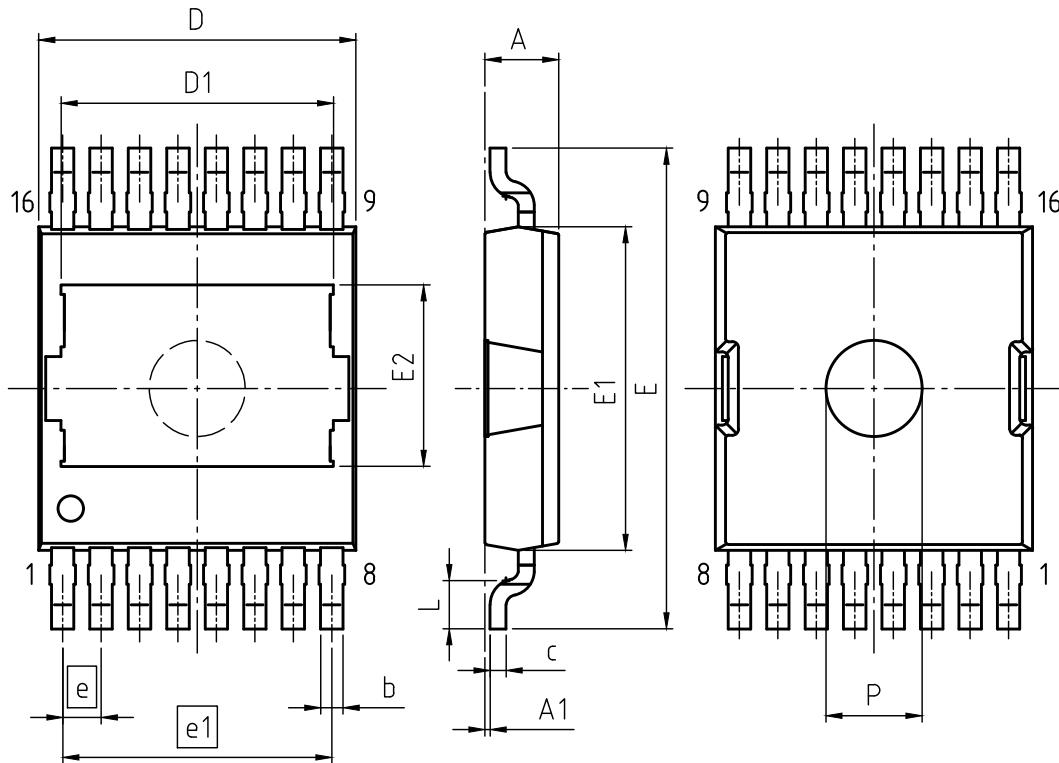


$V_{B(DSS)}=f(T_j)$ ;  $I_D=1 \text{ mA}$

**Diagram Gate charge waveforms**

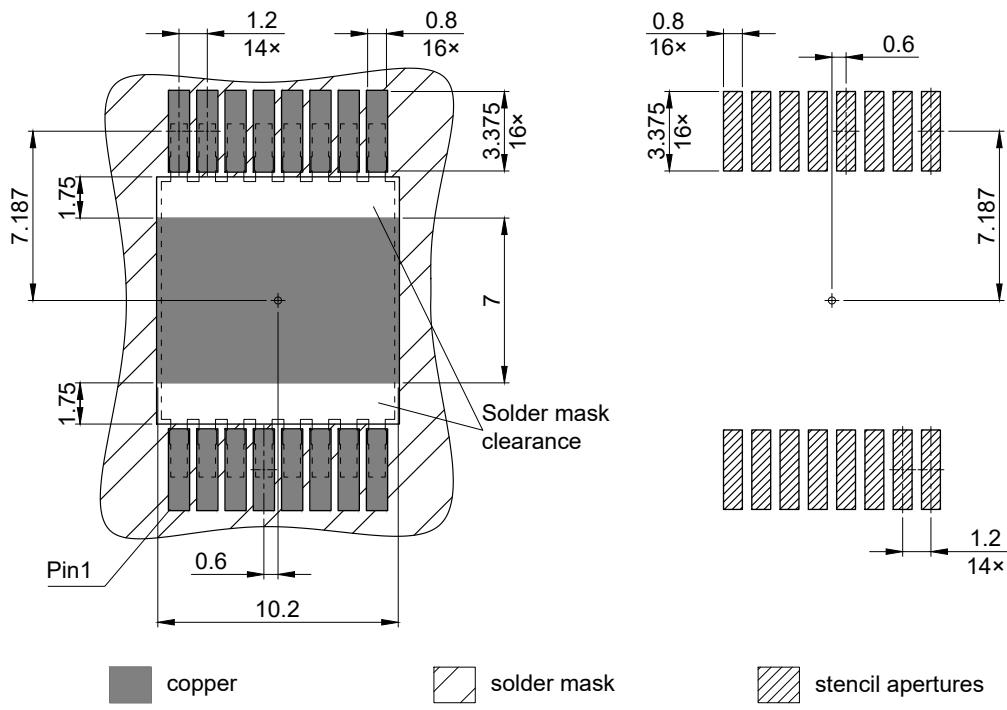


## 5 Package Outlines

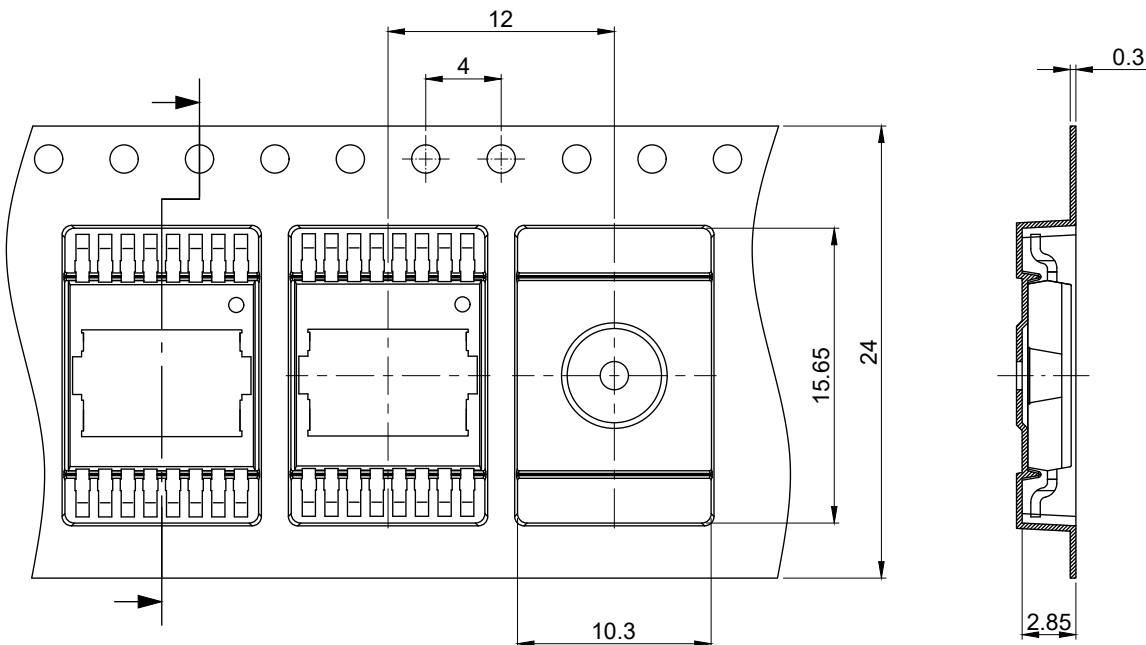


PACKAGE - GROUP NUMBER: <b>PG-HDSOP-16-U01</b>		
REVISION: 01	DATE: 18.12.2020	
DIMENSIONS	MILLIMETERS	
	MIN.	MAX.
A	2.25	2.35
A1	0.01	0.16
b	0.60	0.80
c	0.40	0.60
D	9.70	10.10
D1	8.20	8.40
E	14.80	15.20
E1	10.00	10.30
E2	5.57	5.77
e	1.20	
e1	8.40	
L	1.40	1.60
P	2.90	3.10

**Figure 1 Outline PG-HDSOP-16, dimensions in mm**



**Figure 2 Outline Footprint (PG-HDSOP-16), dimensions in mm**



All dimensions are in units mm

The drawing is in compliance with ISO 128-30, Projection Method 1 [ ]

**Figure 3 Outline Tape (PG-HDSOP-16), dimensions in mm**

## Revision History

IPTC044N15NM5

**Revision: 2023-03-13, Rev. 2.1**

### Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2022-05-05	Release of final version
2.1	2023-03-13	Update Coss max

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